



SAMSUNG ELECTRONICS AMERICA, INC.
American QA Lab
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Date: February 28 , 2015

FCC ID: A3LSMP355

We attest that

@ Test Case : HSDPA / HSUPA Average power check.

@ Reviewer's Comment

HSDPA : Subset 3/4 are mostly higher than the tune up power with MPR.

HSUPA : Subset 2/4 mostly higher than the tune up power with MPR

@ Developer's opinion.

"This each case's powers are satisfy 3GPP power spec. some subset power didn't meet MPR in lab test, but we want to progress with measured value."

Sincerely,

A handwritten signature in black ink, appearing to be "Chanho, Youn".

CHANHO, YOUN

General Manager

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